

View Online at <https://aerobasegroup.com/nsn/6340-01-219-3826>

Semiconductor Material:

Copper

Special Features:

Fire warning flex-print laminated using 1oz copper per qq-c-576 with .001 thick polyamide per mil-p-46112. Laminates to be bonded using thermosetting acrylic adhesive or equal. Total thickness to be .015 max. Consist of flexprint 1, stiffner 4

Functional Description:

B-1b aircraft, used on 709010, nha 710043-1 zzzvg aircraft accessory equipment

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

Yes - demil/mli

Fiig:

T278-m